

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT3676637

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	YIJUN QIAN	12/14/2015
RECEIVING PARTY DATA		
Name:	SHANGHAI HUAHONG GRACE SEMICONDUCTOR MANUFACTURING CORPORATION	
Street Address:	NO.1399 ZU CHONG ZHI ROAD	
Internal Address:	PUDONG NEW AREA	
City:	SHANGHAI	
State/Country:	CHINA	
Postal Code:	201203	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	14978581	
CORRESPONDENCE DATA		
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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ATTORNEY DOCKET NUMBER:	1809-0005	
NAME OF SUBMITTER:	ELIZABETH A. GALLETTA	
SIGNATURE:	/Elizabeth A. Galletta/	
DATE SIGNED:	12/30/2015	
Total Attachments: 2		
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ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated below my name, as an inventor of certain new and useful improvements in

DUAL-PORT SRAM TIMING CONTROL CIRCUIT

for which a non-provisional application is filed herewith in the United States Patent and Trademark Office, which is a corresponding patent application of and claims priority to Chinese application No. 201510024022.6 filed on January 19, 2015

WHEREAS, I possess the entire right, title and interest in the foregoing invention, free from all encumbrances, and have full right to convey his part or all of his interest, and

WHEREAS, **Shanghai Huahong Grace Semiconductor Manufacturing Corporation** (hereinafter referenced as ASSIGNEE), a corporation having a place of business at **No. 1399 Zu Chong Zhi Road, Pudong New Area, Shanghai 201203, China**, is desirous of acquiring all rights, title and interest in, to and under said inventions, said applications disclosing the inventions and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;


NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole inventor, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the full, exclusive and entire right, title and interest in the said inventions, said applications, and any divisions, continuations and reissues thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and the right to sue and collect damages for past infringement, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

AND I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time to time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

AND I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reexaminations, reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

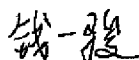
AND I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any reexamination, interference or litigation related thereto;

AND I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.



Witness
Gang Min

Witness



Yijun Qian
No. 288 Ha Lei Road
Pudong New Area, Shanghai 201203
China

2015.12.14
Date